

**SMTAK3 Series**



**Agency Approvals**

AGENCY	AGENCY FILE NUMBER
	E128662

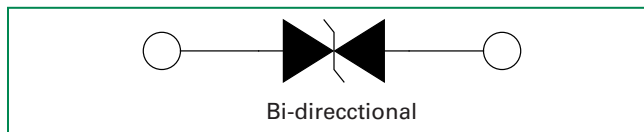
**Maximum Ratings and Thermal Characteristics**  
(T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Storage Temperature Range	T <sub>STG</sub>	(-155 to 150)	°C
Operating Junction Temperature Range	T <sub>J</sub>	(-155 to 125)	°C
Current Rating <sup>1</sup>	I <sub>PP</sub>	3	kA

**Note:**

1. Rated I<sub>pp</sub> measured with 8/20µs pulse.

**Functional Diagram**



**Description**

The SMTAK3 series of high current transient suppressors have been specially designed for use in D.C. line protection and any demanding applications. They offer superior clamping characteristics over standard S.A.D. technologies by virtue of the Littelfuse Foldbak technology. Therefore, any voltage rise due to increased current conduction is contained to a minimum, providing the best possible protection level.

**Features**

- Very low clamping voltage
- Sharp breakdown voltage
- Low slope resistance
- Bi-directional
- Foldbak technology for superior clamping factor
- Symmetric in leads width for easier soldering during assembly.
- IEC 61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Halogen-free
- RoHS compliant
- Glass passivated junction
- Pb-free E4 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

**Electrical Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

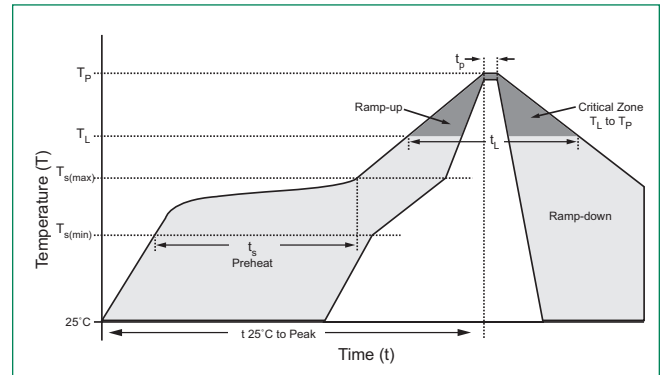
Part Numbers	Part Marking	Standoff Voltage (V <sub>SO</sub> ) Volts	Max. Reverse Leakage (I <sub>R</sub> ) @ V <sub>SO</sub> µA	Typical I <sub>R</sub> @ 85°C (µA)	Reverse Breakdown Voltage V <sub>BR</sub> (Volts) @ I <sub>T</sub>		Test Current I <sub>T</sub> (mA)	Max. Clamping Voltage V <sub>CL</sub> @ I <sub>PP</sub> Peak Pulse Current (I <sub>PP</sub> ) (Note 1)		Max. Temp Coefficient OF V <sub>BR</sub> (%/°C)	Max. Capacitance 0 Bias 10kHz (nF)	Agency Approval
					Min	Max		V <sub>CL</sub> Volts	I <sub>PP</sub> Amps			
SMTAK3-015C	S3-015C	15	10	15	16	19	10	28	3,000	0.1	9.0	X
SMTAK3-058C	S3-058C	58	10	15	64	70	10	110	3,000	0.1	6.0	X
SMTAK3-066C	S3-066C	66	10	15	72	80	10	120	3,000	0.1	6.0	X
SMTAK3-076C	S3-076C	76	10	15	85	95	10	140	3,000	0.1	6.0	X

**Note:**

1. Using 8/20µs wave shape as defined in IEC 61000-4-5.

**Soldering Parameters**

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_A$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_A$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_A$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_s$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		260°C



**Flow/Wave Soldering (Solder Dipping)**

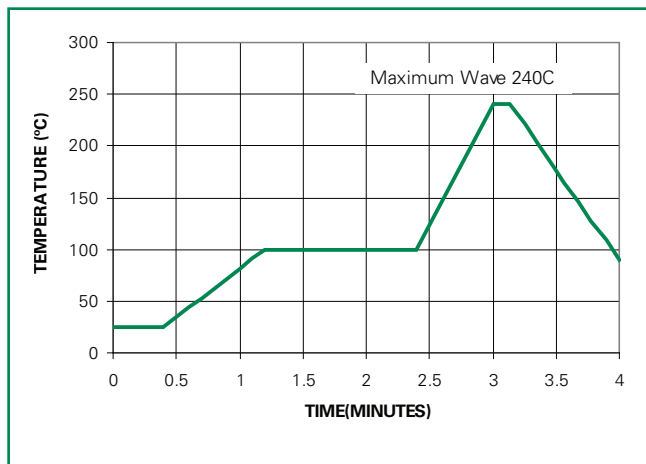
<b>Peak Temperature :</b>	265°C
<b>Dipping Time :</b>	10 seconds
<b>Soldering :</b>	1 time

**Physical Specifications**

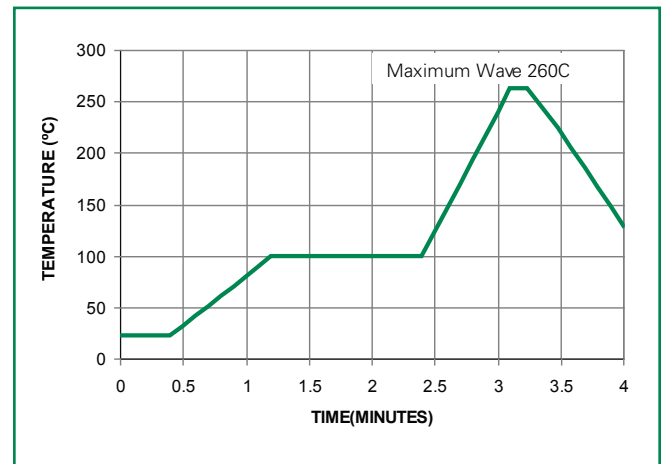
<b>Weight</b>	Contact manufacturer
<b>Case</b>	Epoxy encapsulated
<b>Terminal</b>	Silver plated leads, solderable per MIL-STD-202 Method 208

**Wave Solder Profile**

**Figure 1 - Non Lead-free Profile**

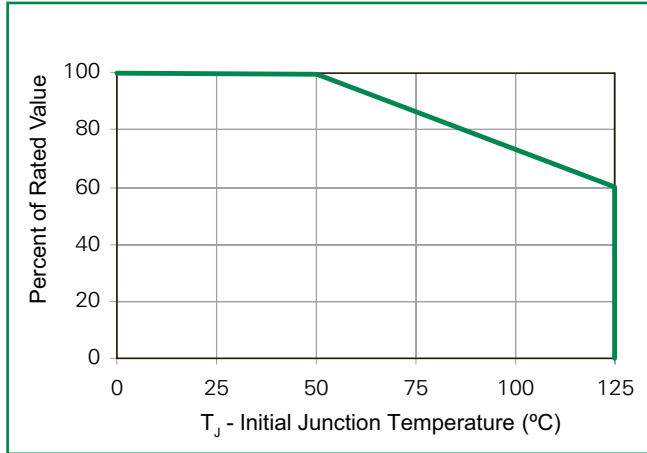


**Figure 2 - Lead-free Profile**

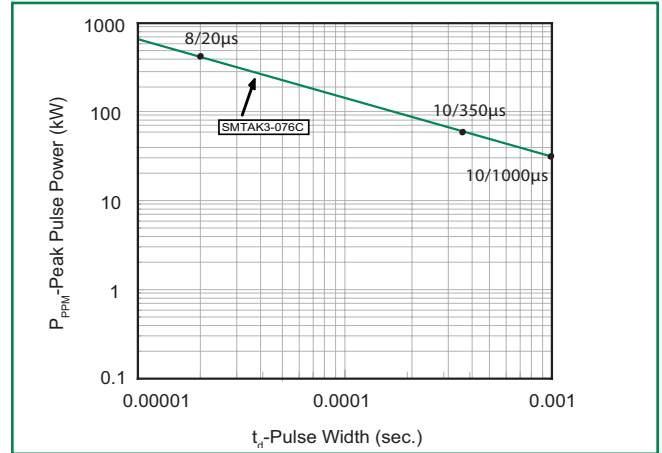


**Ratings and Characteristic Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted)

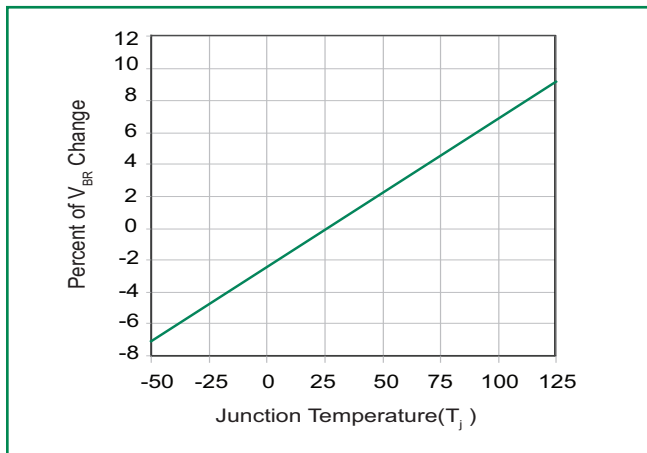
**Figure 3 - Peak Power Derating**



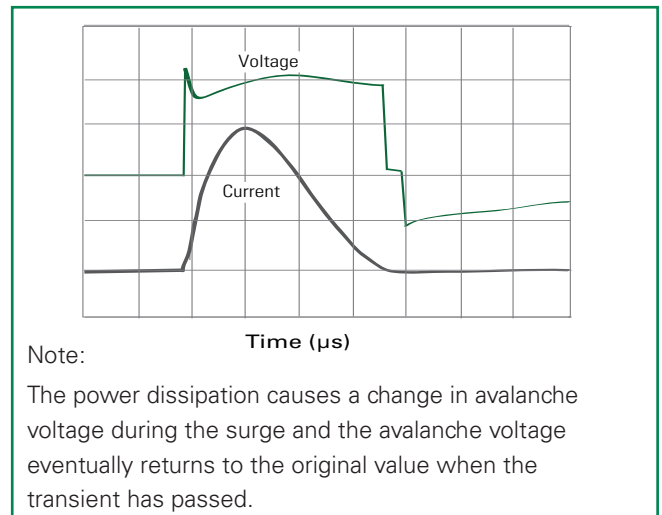
**Figure 4 - Typical Peak Pulse Power Rating Curve**



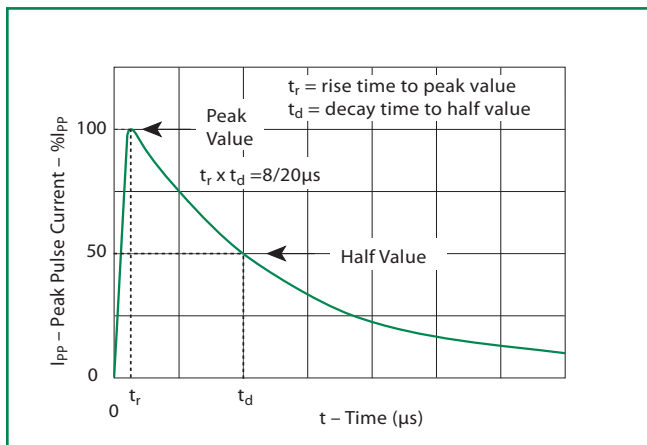
**Figure 5 - Typical  $V_{BR}$  Vs Junction Temperature**



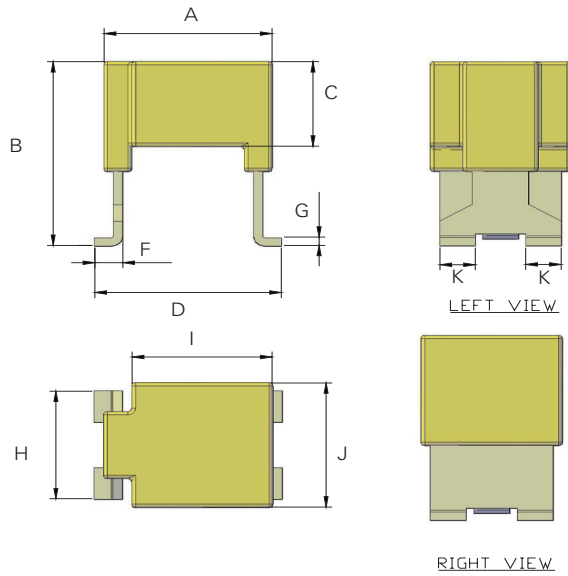
**Figure 6 - Surge Response (8/20 Surge current waveform)**



**Figure 7 - Pulse Waveform**

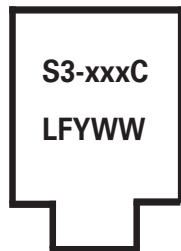


**Dimensions**

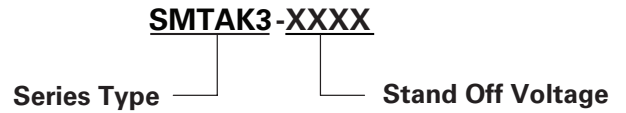


Dimensions	Inches	Millimeters
A	0.354 +0.059/- 0.020	9.0 +1.5/- 0.5
B-SMTAK3-015C	0.362+/- 0.059	9.2+/- 1.5
B-SMTAK3-058C/ 066C/076C	0.437 +/- 0.059	11.1 +/- 1.5
C-SMTAK3-015C	0.205 REF	5.2 REF
C-SMTAK3-058C/ 066C/076C	0.264 REF	6.7 REF
D	0.366 +/- 0.020	9.3 +/- 0.5
F	0.045 +/- 0.012	1.15 +/- 0.3
G	0.020 +/- 0.008	0.5 +/- 0.2
H	0.256+/- 0.020	6.5 +/- 0.5
I	0.319 REF	8.1 REF
J	0.295 +0.059/- 0.020	7.5 +1.5/- 0.5
K	0.075 +/- 0.020	1.9 +/- 0.5

**Part Marking System**



**Part Numbering System**



**Packing Options**

Part Number	Component Package	Quantity	Packing Option	Packing Method
SMTAK3-xxxC	SMTAK Package	100	Box	Vacuum packing